

IN THE U.S. PATENT AND TRADEMARK OFFICE

April 14, 2005

Applicants: Shingo SHIKUWA et al

For: INDUCTION HEATING METHOD OF ARTICLE MADE OF THIN SHEET,
APPARATUS THEREOF AND ARTICLE MADE OF THIN SHEET

Serial No.: 10/524 868 Group: Unknown

Confirmation No.: Unknown

Filed: February 14, 2005 Examiner: Unknown

International Application No.: PCT/JP2004/008987

International Filing Date: June 25, 2004

Atty. Docket No.: Ace Case 13

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(1) and 1.98, enclosed herewith is Form PTO-1449 and the references cited thereon. These references constitute the art known to the Applicants and are believed to be distinguishable from the claimed invention. Accordingly, further comment at this point in time should not be necessary.

Further consideration is respectfully solicited.

Respectfully submitted,


Terryence F. Chapman

TFC/smd

FLYNN, THIEL, BOUTELL	Dale H. Thiel	Reg. No. 24 323
& TANIS, P.C.	David G. Boutell	Reg. No. 25 072
2026 Rambling Road	Ronald J. Tanis	Reg. No. 22 724
Kalamazoo, MI 49008-1631	Terryence F. Chapman	Reg. No. 32 549
Phone: (269) 381-1156	Mark L. Maki	Reg. No. 36 589
Fax: (269) 381-5465	Liane L. Churney	Reg. No. 40 694
	Brian R. Tumm	Reg. No. 36 328
	Steven R. Thiel	Reg. No. 53 685
	Donald J. Wallace	Reg. No. 43 977
	Sidney B. Williams, Jr.	Reg. No. 24 949

Encl: Form PTO-1449 and references cited thereon

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Terryence F. Chapman

TFC/smd

FLYNN, THIEL, BOUTELL	Dale H. Thiel	Reg. No. 24 323
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	Donald J. Wallace	Reg. No. 43 977
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Correspondence: Information Disclosure Statement
dated April 14, 2005
including enclosures listed thereon

INFORMATION
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U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
AA	2004-169321	9/2004	TANAKA et al			
AB						

FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	Sub Class	Translation Yes No
AC	2000-256733	9/2000	Japan	English Abstract and Machine Translation attached		
AD	09-257752	10/1997	Japan	English Abstract attached		
AE	2003-013133	1/2003	Japan	English Abstract attached		
AF	63-279592	11/1988	Japan	English Abstract attached		
AG	06-295782	10/1994	Japan	English Abstract attached		
AH	2003-239018	8/2003	Japan	English Abstract attached		
AI	2003-301218	10/2003	Japan	English Abstract attached		
AJ	10-017933	1/1998	Japan	English Abstract attached		
AK	2003-160062	6/2003	Japan	English Abstract attached		
AL	WO 03/046230	6/2003	WIPO			
AM	WO 02/079525	10/2002	WIPO			

OTHER DOCUMENTS (Including Author, Title, Date, Pages, Etc.)

AN	
AO	

EXAMINER

DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.